



















Datasheet

Distec

DD-0840-XE11

DD-01-003

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2. Revision Record

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Date	Rev.No.	Page	Revision Items	Prepared
2020.09.21	V0		The first release	CJ
2020.09.23	V1		Updated the LED lifetime in Item#6.2 and Added Brightness Value(min) in Item#7.0	CJ



3. General Specifications

DD-0840-XE11 is an 8.4" color TFT-LCD (Thin Film Transistor Liquid Crystal Display) module composed of LCD panel, driver ICs, control circuit and backlight unit. The 8.4" display area contains $1024 \times (RGB) \times 768$ pixels and can display up to 16.7M colors. This product is RoHS compliant.

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	16.7M		1
Viewing Direction	ALL	O'Clock	
Operating temperature	-30~+80	$^{\circ}$	
Storage temperature	-30~+80	\mathbb{C}	
Module size	199.50X149.00X9.7	mm	2
Active Area(W×H)	170.496X127.872	mm	
Number of Dots	1024 X 768	dots	
Power Supply Voltage	3.3	V	
TFT Controller	HX8290-A-LT*2+HX8695-E-LT		
Weight		g	
Interface	LVDS	-	
Surface treatment	Anti-Glare and hard-coating 3H		

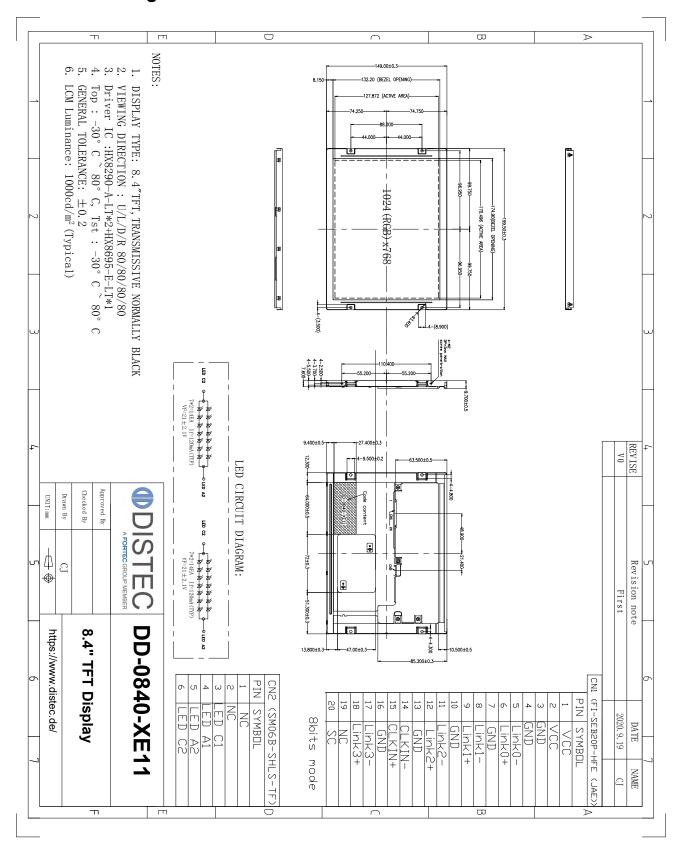
Note 1: Color tune is slightly changed by temperature and driving voltage.

Note 2: Without FPC and Solder.





4. Outline. Drawing





5. Absolute Maximum Ratings(Ta=25°C)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V, Ta=25°C)

Item	Symbol	Min.	Max.	Unit	Note
Dower Supply Voltage	VCC	-0.3	4.0	V	1, 2
Power Supply Voltage	If	0	180	mA	1, 2

Notes:

- 1. If the module is used above these absolute maximum ratings, it may become permanently damaged. Using the module out of the indicated electrical range may cause malfunction and poor reliability.
- 2. V_{CC} >V_{SS} must be maintained.
- 3. Please make sure users are grounded when handing LCD Module.

5.2 Environmental Absolute Maximum Ratings.

ltem .	Stor	age	Opera	Note	
	MIN.	MAX.	MIN.	MAX.	11010
Ambient Temperature	-30℃	80℃	-30℃	80℃	1,2
Humidity	-	-	-	-	3

- 1. The response time will become lower when operated at low temperature.
- 2. Background color changes slightly depending on ambient temperature.

 The phenomenon is reversible.
- 3. Ta<=40 ℃:85%RH MAX.

Ta>=40 C:Absolute humidity must be lower than the humidity of 85%RH at 40 C.



6. Electrical Specifications

6.1 Electrical characteristics for LCD(Vss=0V, Ta=25°C)

Parame	meter Symbol Cond		Condition	Min	Тур	Max	Unit	Note
Power supply		VCC	Ta=25 ℃	3.0	3.3	3.6	V	
Input	'H'	V _{IH}	Ta=25°C	0.7VCC	-	VCC	V	
voltage	'L'	VIL	Ta=25°C	-0.3	-	0.3VCC	V	
	Current of power supply		Ta=25℃	-	180	-	mA	

6.2 LED backlight specification(VSS=0V ,Ta=25°C)

Item	Symbol	Min	Тур	Max	Unit	Note
Supply voltage	VF	18.9	21.0	23.1	V	
Supply Current	lf	-	120*2	-	mA	
Power Consumption	PL	-	5.04	-	W	
Uniformity	∆Вр	75	80	-	%	
Life Time	time	50K	-	-	hours	1

Note 1: Brightness to be decreased to 50% of the initial value at ambient temperature TA=25 ${\mathcal C}$





6.3 Interface signals

6.3.1 CN 1(Interface Signal)

Used connector: 20186-020E-11F (I-PEX) or FI-SEB20P-HFE (JAE)

Corresponding connector: 20197- 20U-F (I-PEX) or FI-S20S[for discrete Wire],

FI-SE20ME[for FPC] (JAE)

Pin No.	Symbol	I/O	Function
1-2	VCC	Р	Power supply
3-4	GND	Р	Ground.
5	LINK0-	ı	LVDS long0 input
6	LINK0+	ı	LVDS lane0 input
7	GND	Р	Ground.
8	LINK1-	ı	LVDS long1 input
9	LINK1+	ı	LVDS lane1 input
10	GND	Р	Ground.
11	LINK2-	I	LVDS long2 input
12	LINK2+	I	LVDS lane2 input
13	GND	Р	Ground.
14	CLKIN-	Ι	LVDS CLK input
15	CLKIN+	I	LVDS CLK input
16	GND	Р	Ground.
17	LINK3-	I	LVDS lone2 input
18	LINK3+	I	LVDS lane3 input
19	NC	-	No connection
20	SC	I	Scan direction control (Low=Normal, High=Reverse)



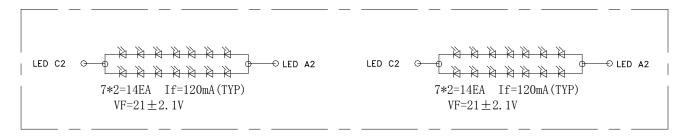
6.3.1 CN 2(Backlight)

Backlight-side connector: SM06B-SHLS-TF (LF)(SN) (JST)

Corresponding connector: SHLP-06V-S-B (JST)

Pin No.	Symbol	I/O	Function
1-2	NC	-	This pin should be open.
3	LED C1	Р	LED cathode 1
4	LED A 1	Р	LED anode 1
5	LED A 2	Р	LED anode 2
6	LED C 2	Р	LED cathode 2

LED CIRCUIT DIAGRAM:





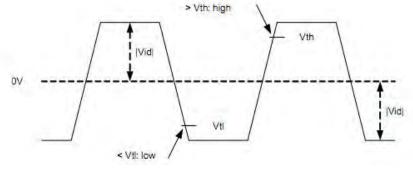
6.4 AC Characteristics

6.4.1 For the digital circuit: LVDS mode

B	Countries 1	o and and an			91006		
Parameter	Symbol	Condition	Min.	Тур.	Max. +0.1 - 1.7- V _{id} /2 1.7 0.6	Unit	
Differential input high Threshold voltage	Vth	Vcm=1.2V		100	+0.1	٧	
Differential input low threshold voltage	Vtl	(3)	-0.1	-	845 I	V	
Differential input common Mode voltage	V _{GM}	•	1	1.2	1.7- V _{id} /2	٧	
LVDS input voltage	V _{INLV}	-	0.7		1.7	V	
Differential input voltage	Vid	34	0.1	741	0.6	V	
Differential input leakage Current	Ilvleak	ą.	-10	-	+10	μА	

Single-ended: LVCLKP(R), LVCLKN(R), LVD[3:0]P(R), LVD[3:0]N(R) Vcm Vivid

Differential: LVCLKP(R)-LVCLKN(R), LVD [3:0]P(R)-LVD [3:0]N(R)



6.4.2 For the analog circuit: Normal mode



Dovomatan	Cumbal	Conditions	Spec.			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Analog positive supply voltage	VSP	VSP is generated by PFM, VSPS [4:0]=14h, with proper settings and components.	6.7	7	7.3	٧
Analog negative supply voltage	VSN	VSN is generated by PFM, VSNS [4:0]=14h, with proper settings and components.	-7.3	-7	-6.7	٧
Source driver positive supply voltage	VSDP	VSP≧7V,VSDPS[4:0]=14h, loading current=0	6.65	6.8	6.95	٧
Source driver negative supply voltage	VSDN	VSN=-7V, VSDNS[4:0]=14h, loading current=0	-6.95	-6.8	-6.65	٧
Output for positive gamma reference high voltage	VGMPHO	VSDP≧6.8V, VGMPHS[4:0]=0x1Ah	6.48	6.6	6.72	٧
Output for positive gamma reference voltage	VGMPMO	VSDP≥6.8V, VGMPHS[4:0]=0x1Ah VGMPLS[3:0]=0x00h	3.3	3.4	3.5	٧
	-				•	_
Output for positive gamma reference low voltage	VGMPLO	VGMPLS[3:0]=0x00h	0.12	0.2	0.28	V
Output for negative gamma reference high voltage	VGMNHO	VSDN≦-6.8V, VGMNHS[4:0]=0x1Ah	-6.72	-6.6	-6.48	٧
Output for negative gamma reference voltage	VGMNMO	VSDN≦-6.8V, VGMNHS[4:0]=0x1Ah VGMNLS[4:0]=0x00h	-3.5	-3.4	-3.3	٧
Output for negative gamma reference low voltage	VGMNLO	VGMNLS[4:0]=0x00h	-0.28	-0.2	-0.12	٧
VCOM voltage	VCOM	VCOMS[7:0]=0x80h	-1.53	-1.48	-1.43	٧
Source output voltage, positive polarity	V _{SDOP}	(+)	0.2	4.1	VSDP-0.2	٧
Source output voltage, negative polarity	V _{SDON}		VSDN+0.2	4	-0.2	٧
Positive power supply	VGH	VGH is generated by charge pump, VGHS[3:0]=0x05h, loading current=0	14.6	15.6	16.6	V
Negative power supply	VGL	VGL is generated by charge pump, VGLS[2:0]=0x02h, loading current=0	-11	-10	-9	٧



Parameter Sy	Combal	Sumbal Canditions		Spec.			
	Symbol	Conditions	Min.	Тур.	Max.	Unit	
		V _{SDOP} =0.5V to VSDP-0.5V, V _{SDON} =VSDN+0.5V to -0.5V	-155	7	10	mV	
Source output voltage deviation	V _{OD}	VsDoP=0.2V to 0.5V or VsDoP=VSDP-0.5V to VSDP-0.2V, VsDoN=VSDN+0.2V to VSDN+0.5V or VsDoN=-0.5V to -0.2V	-	9.	15	mV	
Standby current (VCC1 + VCC2)	I _{STBvcc}	"STBYB=0" and all inputs are default.	- 9		100	μA	
Standby current (VSN or VSP)	I _{STB}	"STBYB=0", VSP or VSN external input	.30		100	μA	

6.4.3 LVDS mode AC electrical characteristics

Barriera	Complete	Spec.			11.00
Parameter	Symbol	Min.	Тур.	Max.	Unit
Clock frequency	F _{LVCYC}	20		85	MHz
Clock period	T _{LVCYC}	11.76		-	ns
1 data bit time	UI		1/7	- 1 -	TLVCYC
Clock high time	T _{LVCH}	2.8	4	4.2	UI
Clock low time	T _{LVCL}	2.8	3	4.2	UI
Position 1	T _{POS1}	-0.2	0	0.2	UI
Position 0	T _{POS0}	0.8	1	1.2	UI
Position 6	T _{POS6}	1.8	2	2.2	UI
Position 5	T _{POS5}	2.8	3	3.2	UI
Position 4	T _{POS4}	3.8	4	4.2	UI
Position 3	T _{POS3}	4.8	5	5.2	UI
Position 2	T _{POS2}	5.8	6	6.2	UI
Input eye width	T _{EYEW}	0.6	-		UI
Input eye border	T _{EX}			0.2	UI
LVDS wake up time	T _{ENLVDS}			150	us

LVDS with SSC



Parameter	Combal	Condition	Spec.			110.04
	Symbol		Min.	Тур.	Max	Unit
Modulation Frequency	SSCMF	LVDS clock frequency center at 80MHz	1	· ·	200	KHz
		LVDS clock frequency center at 60MHz	10-57	427	150	KHz
		LVDS clock frequency center at 40MHz			100	KHz
		LVDS clock frequency center at 20MHz	17.2		50	KHz
Modulation Rate	SSCMR	LVDS clock frequency + SSCMR in the range of 20MHZ~85Mhz	100	-	±5	%

6.4.4 TTL mode AC electrical characteristics

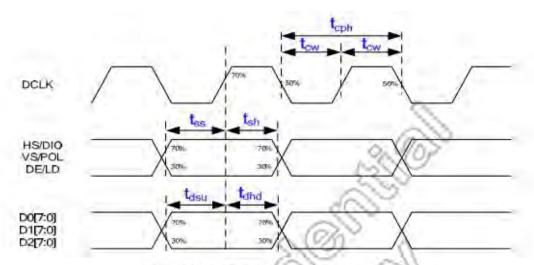


Figure 11.5: Input signal timing

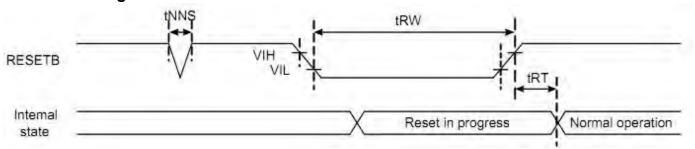
Input data/sync. parameters

(VCC1=VCC2=VCCIF=2.7V to 3.6V, VSS1=VSS2=VSSA=0V, Top=-40~105°C)

Danamatan	Oumbal		Maria		
Parameter	Symbol	Min.	Тур.	Max.	Unit
DCLK period	(Tooh	16.67		*	ns
DCLK duty ratio	Tcw	40	50	60	%
Data setup time	T _{dsu}	5		8	ns
Data hold time	Tend	5		- 5	ns
VS/POL setup time	Tss	5		- 8	ns
VS/POL hold time	T _{sh}	5		- 8	ns
HS/DIO setup time	Tse	5		- 5	ns
HS/DIO hold time	T _{sh}	5	Air	1.6	ns
DE/LD setup time	T _{ss}	5		1.0	ns
DE/LD hold time	T _{sh}	5		1.00	ns

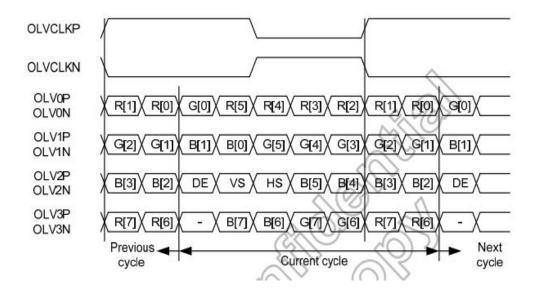


6.5 Reset timing



Clausel	Devenuetes	Symbol	Spec.			Unit
Signal	Parameter		Min.	Тур.	Max.	Unit
RESETB	Reset pulse width	tRW	10		0.00	μs
	Reset complete time	tRT		7	5	μs
	Negative spike noise width	tNNS	- 67 m	- 4	100	ns

6.6 LVDS interface data format



VESA 8bit mode





6.7 Input timing table

Parameter	Symbol	102	Unit			
		Min.	Тур.	Max.		
DCLK frequency	FDCLK	49.0	50.0	79.7	MHz	
Horizontal valid data	t _{hd}		1024		DCLK	
1 Horizontal line	t _h	1053	1066	1331	DCLK	
Vertical valid data	t _{vd}		768		Н	
1 Vertical field	t _v	775	781	998	Н	
Frame rate	FR	8 1	60	8	Hz	





7. Optical Characteristics

Item	Sy	mbol	Condition	Min.	Тур.	Max.	Unit	Note
Brightness	ı	Вр	<i>θ</i> =0°	850	1000	-	Cd/m ²	1
Uniformity	_	1Bp	Ф=0°	75	80	-	%	1,2
	3	:00		75	80	-	Deg	
Viewing	6	:00	0	75	80	-		
Angle	9	:00	- Cr≥10	75	80	-		3
	12	2:00		75	80	-		
Contrast Ratio		Cr		800	1000	-	-	4
Response Time	Т	r+Tf	<i>Ta</i> =25°C Φ=0°	-	22	25	ms	5
	۱۸/	х		Typ -0.05	0.302	Typ +0.05	-	1,6
	W	у			0.326		-	
	R	х			0.638		-	
Color of CIE		у			0.319		-	
Coordinate		х	<i>θ</i> =0° Φ=0°		0.265		-	
	G	у			0.577		-	
	В	х			0.141		-	
		у			0.091		-	
NTSC Ratio		S		-	70	-	%	



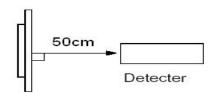
Note: The parameter is slightly changed by temperature, driving voltage and material

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment BM-7 (Φ5mm)

Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25 ℃.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.

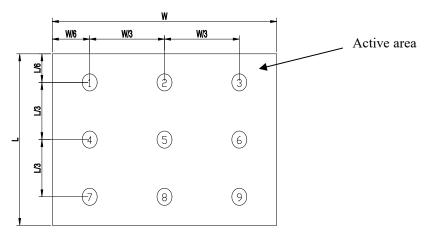


Note 2: The luminance uniformity is calculated by using following formula.

 $\triangle Bp = Bp (Min.) / Bp (Max.) \times 100 (%)$

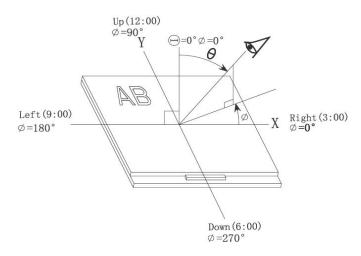
Bp (Max.) = Maximum brightness in 9 measured spots

Bp (Min.) = Minimum brightness in 9 measured spots.

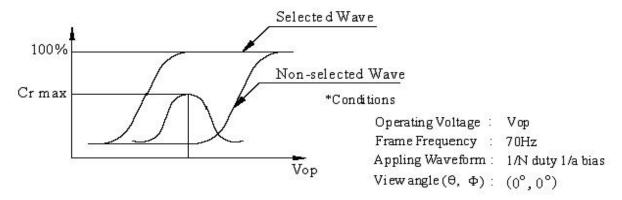




Note 3: The definition of viewing angle: Refer to the graph below marked by θ and Φ



Note 4: Definition of contrast ratio.(Test LCD using DMS501)

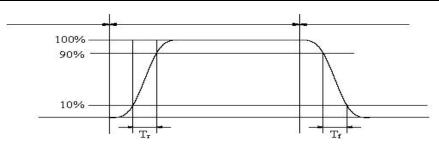


$$Contrast \ ratio(Cr) = \frac{Brightness \ of \ selected \ dots}{Brightness \ of \ non-selected \ dots}$$

Note 5: Definition of Response time. (Test LCD using DMS501):

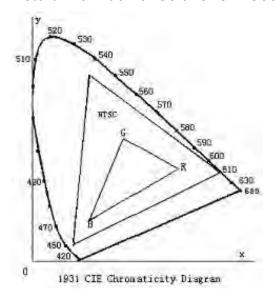
The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.





The definition of response time

Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.

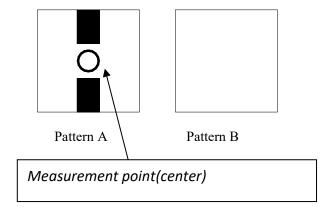


Color gamut:

$$S = \frac{area~of~RGB~triangle}{area~of~NTSC~triangle} \times 100\%$$

Note 7: Definition of cross talk.

Cross talk ratio(%)=|pattern A Brightness-pattern B Brightness|/pattern A Brightness*100



Electric volume value=3F+/-3Hex





8. Reliability Test Items and Criteria

Test Item	Test condition	Remark
High Temperature Storage	Ta = 80℃ 240hrs	Note1,Note3, 4
Low Temperature Storage	Ta = -30℃ 240hrs	Note1, Note3, 4
High Temperature Operation	Ta = 80℃ 240hrs	Note2,Note3, 4
Low Temperature Operation	Ta = -30℃ 240hrs	Note1,Note3, 4
Operation at High Temperature/Humidity	+60℃, 90%RH 240hrs	Note3, 4
Thermal Shock	-30°C/30 min ~ +80°C/30 min for a total 50 cycles, Start with cold temperature and end with high temperature.	Note3,4
Vibration Test	Frequency range:10~55Hz Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X. Y. Z. (6 hours for total)	
Mechanical Shock (NON-OPERATION)	Shock level: 1470 m/s 2 (150G) Waveform: half sinusoidal wave, 2 ms Number of shocks: one shock input in each direction of three mutually perpendicular axes for a total of six shock inputs	
Vibration Test (NON-OPERATION)	Vibration level: 9.8 m/s 2 (1.0G) Waveform: sinusoidal Frequency range: 5 to 500 Hz Frequency sweep rate: 0.5 octave /min Duration: one sweep from 5 to 500 Hz in each of three mutually perpendicular axis(each x,y,z axis: 1 hour, total 3 hours)	
Package Drop Test	Height:60cm 1 corner, 3 edges, 6 surfaces	
CONTACT DISCHARGE (OPERATION)	150pF, 330Ω , 8kV, 10 times at 1 sec interval	
SIGNAL PIN DISCHARGE (NON-OPERATION)	200pF, 0Ω , 200V, 10 times at 1 sec interval	



- Note 1: Ta is the ambient temperature of samples.
- Note 2: Ts is the temperature of panel's surface.

Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

Note 4: Before cosmetic and function test, the product must have enough recovery time,at least 2 hours at room temperature

9. Precautions for Use of LCD Modules

9.1 Handling Precautions

- 9.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 9.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 9.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 9.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 9.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

Isopropyl alcohol	— Ethyl alcohol		
Solvents other than those	mentioned above may	damage the polarizer.	Especially, do
not use the following:			
— Water	— Ketone	— Aromatic so	lvents

- 9.1.6 Do not attempt to disassemble the LCD Module.
- 9.1.7 If the logic circuit power is off, do not apply the input signals.
- 9.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an





optimum work environment.

- a. Be sure to ground the body when handling the LCD Modules.
- b. Tools required for assembly, such as soldering irons, must be properly ground.
- c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

9.2 Storage precautions

- 9.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 9.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0 $^{\circ}$ $^{\circ}$ $^{\circ}$ 40 $^{\circ}$

Relatively humidity: ≤80%

- 9.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 9.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

END



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